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(71) Applicant (for all designated States except US): TOKYO ELECTRON LIMITED [JP/JP]; TBS Broadcast Center, 3-6, Akasaka 5-chome, Minato-ku, Tokyo 107-8481 (JP).

(72) Inventors; and

(75) Inventors/Applicants (for US only): HATAMURA, Yasunori [JP/US]; Apt. 28, 3 Beverly Commons Drive, Beverly, MA 01915 (US). HINATA, Kunihko [JP/JP]; 412 Ninomiya, Misaka-cho, Higashiyatsushiro-gun, Yamanashi, 406-0807 (JP).

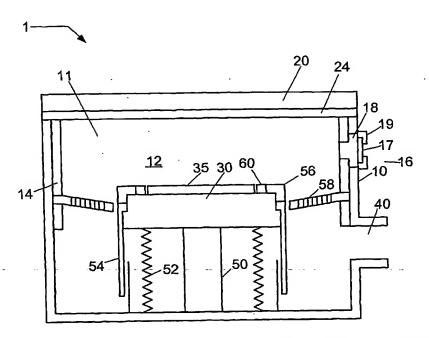
(74) Agent: MAIER, Gregory, J.; Oblon, Spivak, McClelland, Maier & Neustadt, P.C., 1940 Duke Street, Alexandria, VI 22314 (US).

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(54) Title: METHOD AND APPARATUS FOR REDUCING SUBSTRATE BACKSIDE DEPOSITION DURING PROCESSING



(57) Abstract: A focus ring assembly configured to be coupled to a substrate holder comprises a focus ring and a secondary focus ring coupled to the focus ring, wherein the secondary focus ring is configured to reduce the deposition of process residue on a backside surface of the substrate.

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